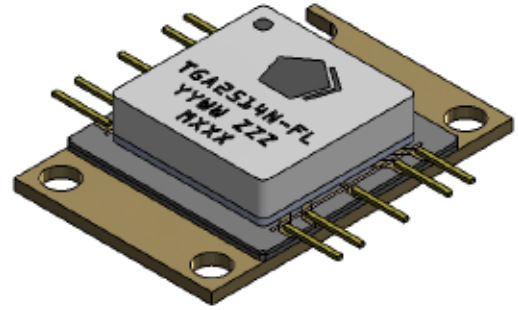


Product Description

Qorvo's TGA2514N-FL is a packaged Ku-band power amplifier operating from 13–16 GHz. Fabricated on Qorvo's production 0.25 um GaAs pHEMT process (QPHT25), the TGA2514N-FL delivers 6.5 W of saturated output power with 24 dB of small signal gain. Performance is ideal for VSAT transmitters, data links and point to point radios.

To support easy system integration, the TGA2514N-FL is offered in a 10-pin flange-mounted package, offering robust handling and good thermal management. In addition, both RF ports have integrated DC blocking capacitors and are fully matched to 50 ohms.

Lead free and RoHS compliant.

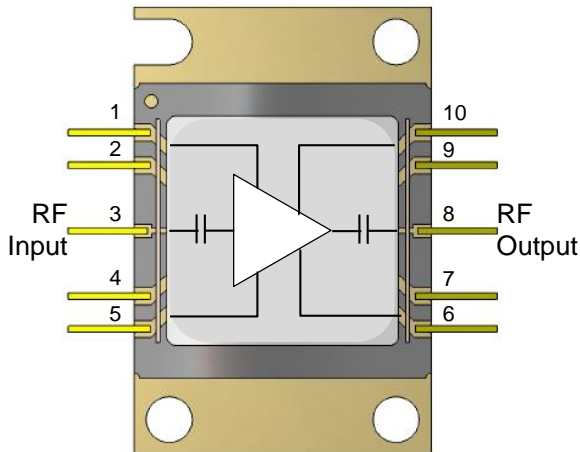


Product Features

- Frequency Range: 13 – 16 GHz
- Saturated Output Power: 38 dBm
- Small Signal Gain: 24 dB
- Input and Output Return Loss: 14 dB
- Bias Condition (VD/IDQ): 8.0V/2.6 A
- Package Size: 0.448 x 0.682 x 0.120 inches (11.379 x 17.323 x 3.048 mm)

Performance is typical across frequency. Please reference electrical specification table and data plots for more details

Functional Block Diagram



Applications

- Ku Band VSAT Transmitter
- Point to Point Radio

Ordering Information

Part No.	Description
TGA2514N-FL	13 – 16 GHz Power Amplifier
1127039	Evaluation Board



TGA2514N-FL

13 – 18 GHz Power Amplifier

Absolute Maximum Ratings

Parameter	Value / Range
Drain Voltage (V_D)	9.0 V
Drain Current (I_D)	3.8 A
Gate Voltage Range (V_G)	-5 to 0 V
Gate Current (I_G)	-18 to +18 mA
Input Power, CW (P_{IN})	21 dBm
Power Dissipation (P_{DISS})	33.3 W
Operating Channel Temperature	200 °C

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Recommended Operating Conditions

Parameter	Value / Range
Drain Voltage (V_D)	8.0 V
Gate Voltage (V_S)	-0.65 V
Drain Current (I_{DQ})	2.6 A
Temperature Range	-40 to +85 °C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

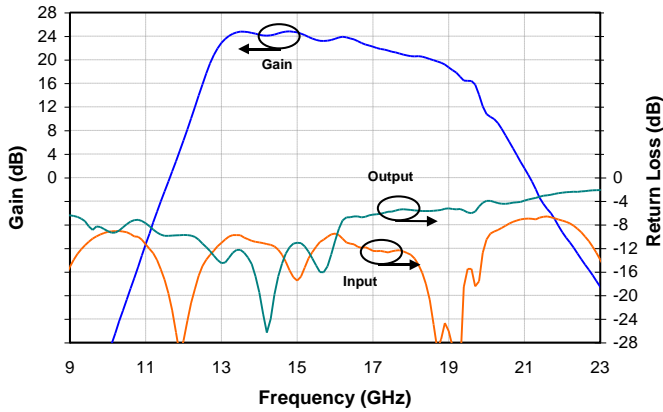
Parameter	Min	Typ	Max	Units
Frequency Range	13		16	GHz
Small Signal Gain		24		dB
Saturated Output Power		38		dBm
Input Return Loss		14		dB
Output Return Loss		14		dB

Test conditions, unless otherwise noted: Temp = 25 °C, V_D = 8.0 V, I_{DQ} = 2.6 A

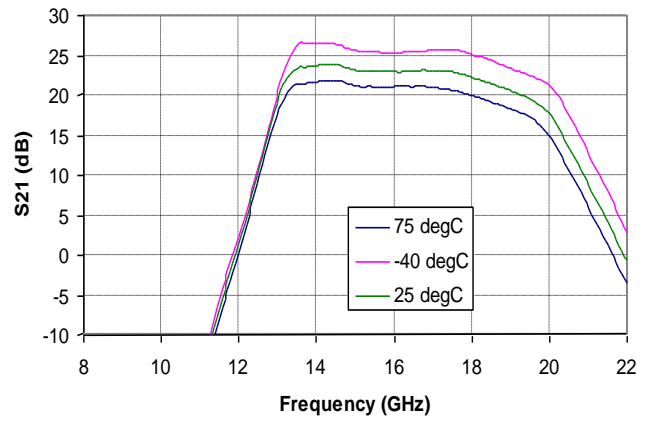
Typical Performance – Small and Large Signal

Test conditions, unless otherwise noted: Temp = 25 °C, $V_D = 8.0$ V, $I_{DQ} = 2.6$ A

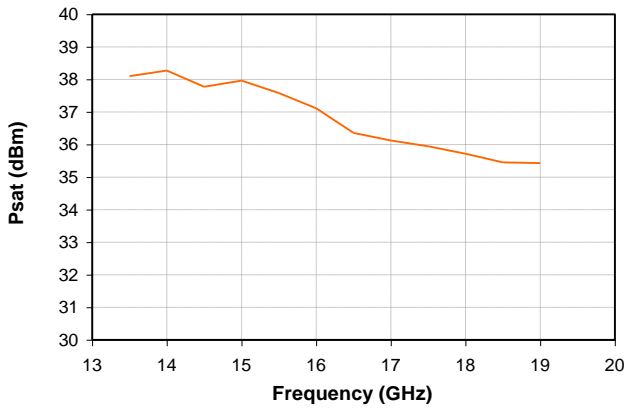
Gain and Return Loss vs. Frequency



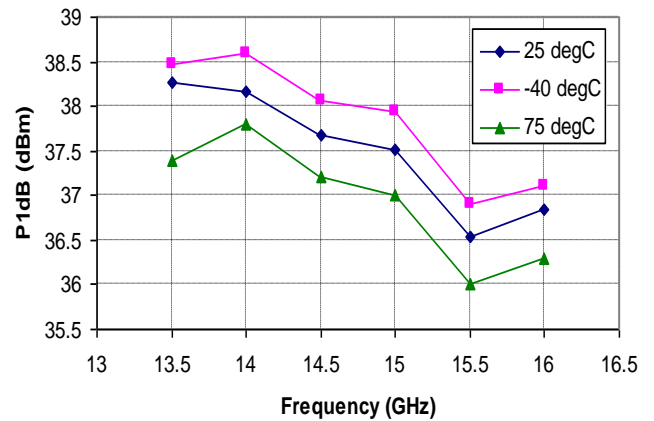
Gain vs. Frequency vs. Temperature



Saturated Output Power vs. Frequency



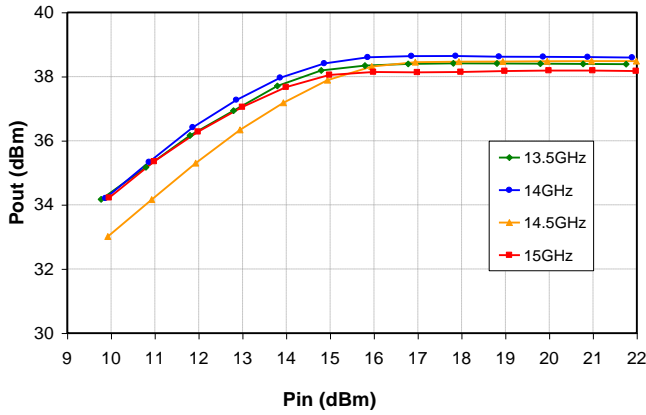
P1dB vs. Frequency vs. Temperature



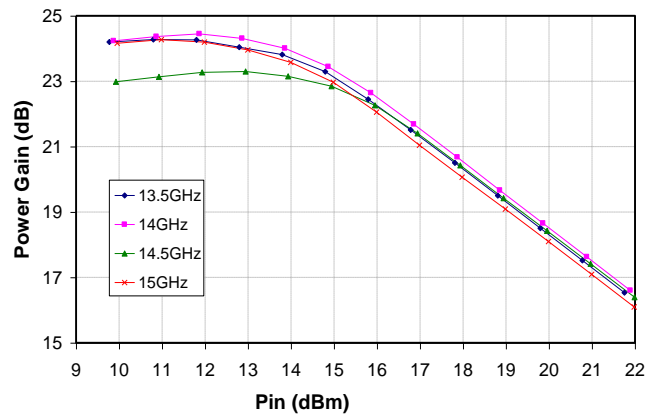
Typical Performance – Large Signal

Test conditions, unless otherwise noted: Temp = 25 °C, $V_D = 8.0$ V, $I_{DQ} = 2.6$ A

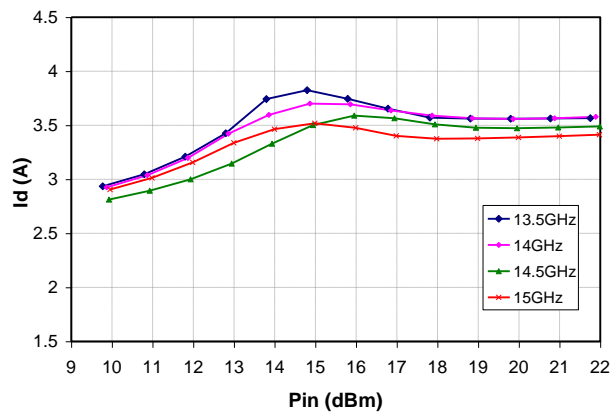
Output Power vs. Input Power vs. Frequency



Gain vs. Input Power vs. Frequency



Drain Current vs. Input Power vs. Frequency



Thermal and Reliability Information

Parameter	Test Conditions	Value	Units
Thermal Resistance (θ_{JC}) ⁽¹⁾	$T_{BASE} = 70\text{ }^{\circ}\text{C}$, $V_D = 8\text{ V}$ $I_{DQ} = 2.6\text{ A}$, $P_{DISS} = 20.8\text{ W}$	3.9	$^{\circ}\text{C/W}$
Channel Temperature (T_{CH}) ⁽¹⁾		151	$^{\circ}\text{C}$
Median Lifetime (T_M)		9.3E5	Hrs
Thermal Resistance (θ_{JC}) ⁽¹⁾	$T_{BASE} = 70\text{ }^{\circ}\text{C}$, $V_D = 8\text{ V}$ $I_{DQ} = 2.6\text{ A}$, $P_{DISS} = 22.5\text{ W}$ (Under RF Drive)	3.9	$^{\circ}\text{C/W}$
Channel Temperature (T_{CH}) ⁽¹⁾		158	$^{\circ}\text{C}$
Median Lifetime (T_M)		5.2E5	Hrs

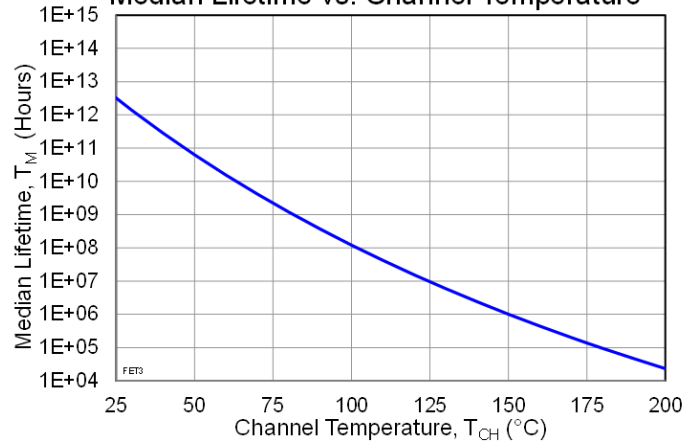
Notes:

1. Thermal resistance is referenced to the back of package ($70\text{ }^{\circ}\text{C}$)

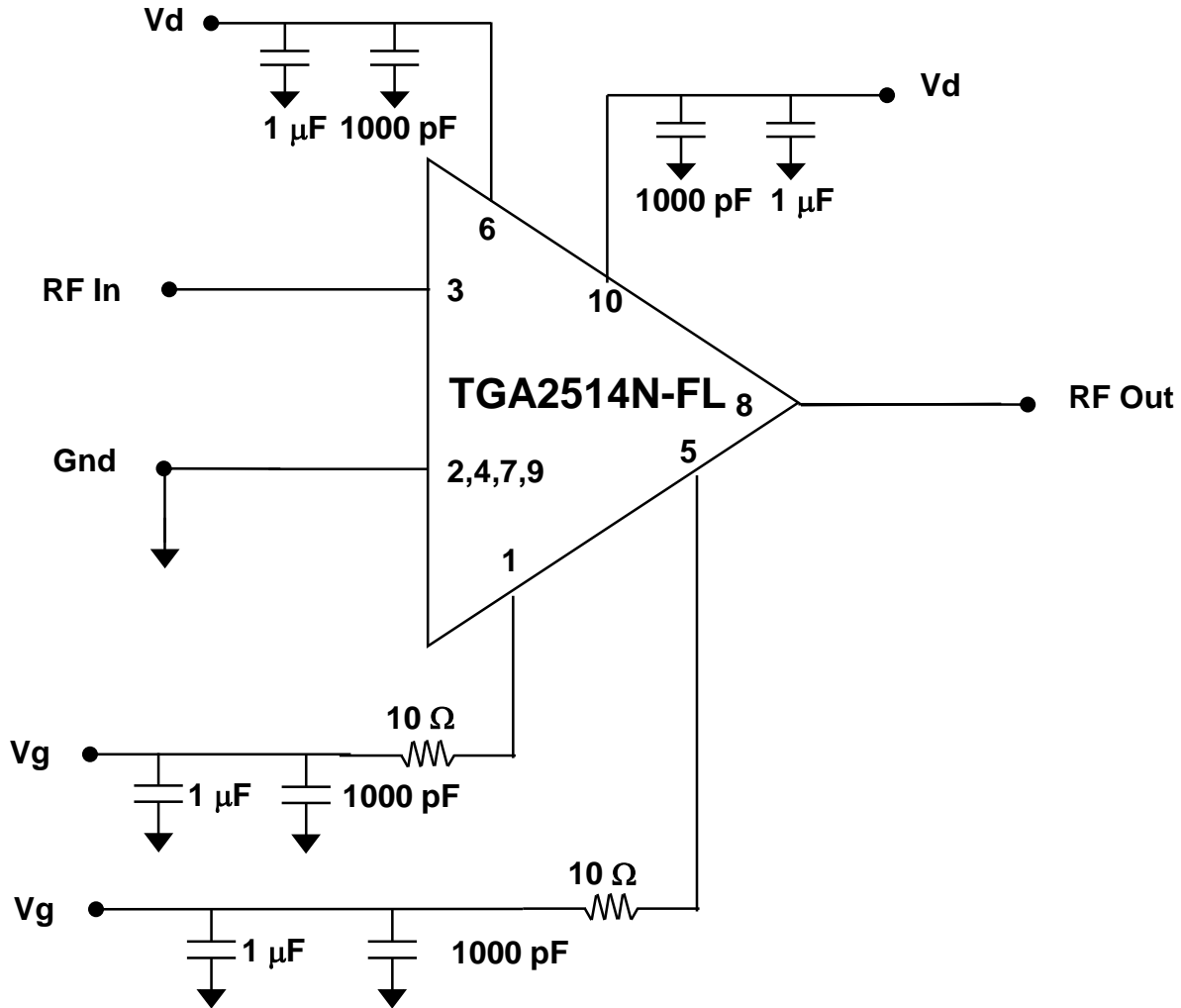
Median Lifetime

Failure Criterion = 10% reduction in $I_{D\text{ MAX}}$

Median Lifetime vs. Channel Temperature



Applications Circuit



Notes:

1. V_G can be biased from either pin 1 or pin 5.
2. V_D must be biased from both sides (Pins 6 and 10)

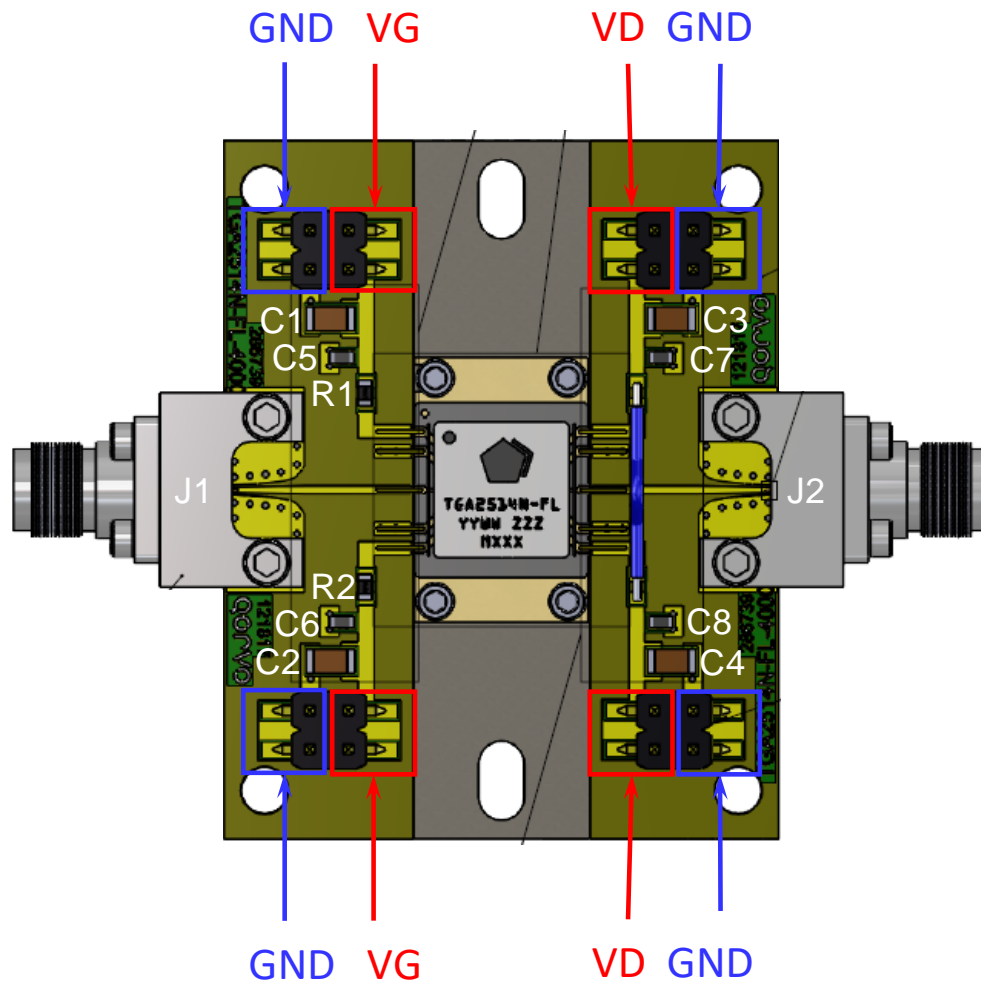
Bias Up Procedure

1. Set I_D limit to 3.3 A, I_G limit to 18 mA
2. Apply -1.5 V to V_G
3. Apply $+8\text{ V}$ to V_D ; ensure I_{DQ} is approx. 0 mA
4. Adjust V_G until $I_{DQ} = 2.6\text{ A}$ ($V_G \sim -0.65\text{ V Typ.}$).
5. Turn on RF supply

Bias Down Procedure

1. Turn off RF supply
2. Reduce V_G to -1.5 V ; ensure I_{DQ} is approx. 0 mA
3. Set V_D to 0 V
4. Turn off V_D supply
5. Turn off V_G supply

Evaluation Board (EVB) Assembly Drawing



PCB NOTES:

1. RF Layer is 0.010" thick Rogers Corp. RO4350, $\epsilon_r = 3.38$. Metal layers are 0.5 oz. copper. The microstrip line at the connector interface is optimized for the Southwest Microwave end launch connector 1092-01A-5.

Bill of Materials

Reference Des.	Value	Description	Manuf.	Part Number
C1, C2, C3, C4	1.0 uF	CAP, 1uF, 5% 50V, X7R, 1206	Various	–
C5, C6, C7, C8	1000 pF	CAP, 1000pF, 5%, 50V, NP0, 0603	Various	–
R1, R2	0 Ω	RES, 0 OHM, 1/10W, 0603	Various	–
J1, J2	2.92 mm	CONNECTOR, FEMALE, ENDLAUNCH	Southwest Microwave	1092-01A-5



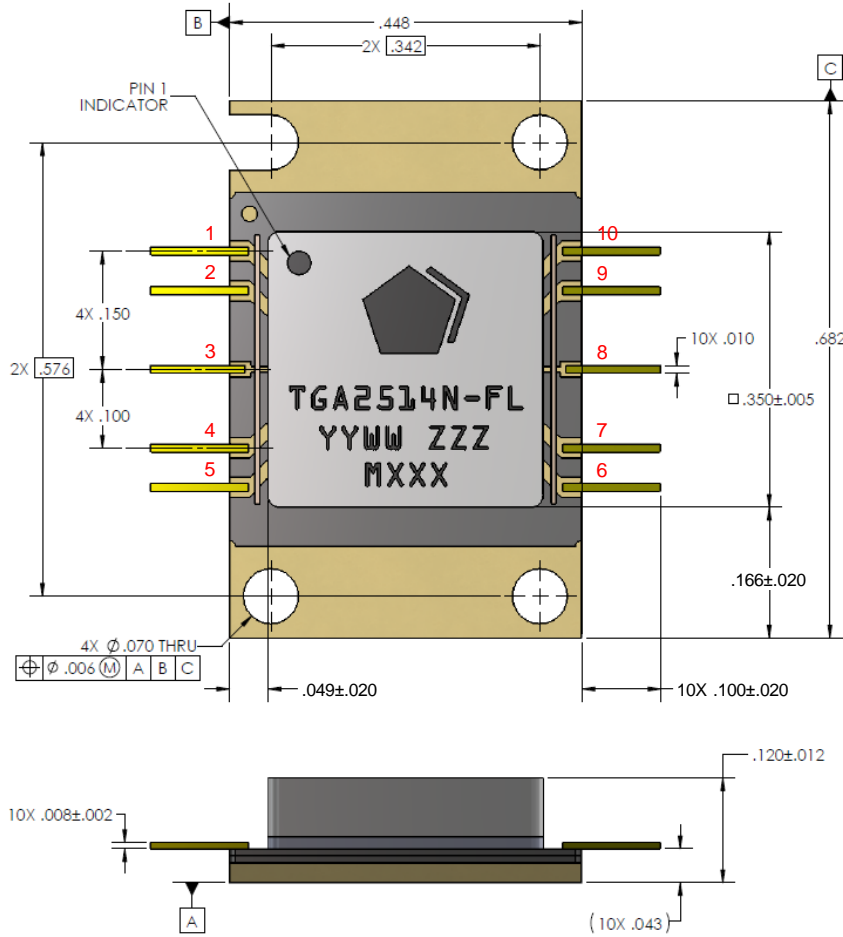
TGA2514N-FL

13 – 18 GHz Power Amplifier

Assembly Notes

1. Carefully clean the PC board and package leads with alcohol. Allow it to dry fully.
2. To improve the thermal and RF performance, Qorvo recommends attaching a heat sink to the bottom of the PCB and apply thermal compound (Arctic Silver 5 recommended) or a 4 mil indium shim between the heat sink and the package.
3. Apply no-flux solder to each pin of the TGA2514N-FL. The component leads should be manually soldered, and the package should not be subjected to conventional reflow processes. The use of no-clean solder to avoid washing after soldering is recommended.

Mechanical Information



- NOTES:
1. PACKAGE BASE: CERAMIC ON METAL FLANGE.
 2. PACKAGE LID: PLASTIC.
 3. ALL METALIZED FEATURES ARE GOLD PLATED.
 4. THE PART IS EPOXY SEALED.
 5. PART MARKING:
 TGA2514N-FL: PART NUMBER
 YY: PART ASSY YEAR
 WW: PART ASSY WEEK
 ZZZ: SERIAL NUMBER
 MXXX: BATCH ID

THE GENERAL TOLERANCE IS $\pm .006$ UNLESS OTHERWISE SPECIFIED
 ALL DIMENSIONS ARE IN INCHES

Pin Description

Pad No.	Symbol	Description
1,5	V_G	Gate Voltage; bias network is required, part can be biased from either pin
2,4,7,9	GND	Ground
3	RF Input	RF Input; 50 Ω , AC coupled
6,10	V_D	Drain Voltage; bias network is required, part must be biased from both pins
8	RF Output	RF Output; 50 Ω , AC coupled

Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 0B	JEDEC Standard JESD22 A114
MSL – Moisture Sensitivity Level	3	JEDEC standard J-STD-020



Caution!
ESD-Sensitive Device

Solderability

The component leads should be manually soldered, and the package should not be subjected to conventional reflow processes. Soldering of the component leads is compatible with the latest version of J-STD-020, lead-free solder, 260 °C. The use of no-clean solder to avoid washing after soldering is recommended.

RoHS Compliance

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU. This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com

Tel: 1-844-890-8163

Email: customer.support@qorvo.com

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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